



1/28/05

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Lap-Wai Chow, et al.) Re: Information Disclosure
Serial No.: 09/768,904) Statement
Filed: January 24, 2001) Group: 2815
For: "INTEGRATED CIRCUIT)
PROTECTION...") Examiner: Nguyen, Joseph H.
) Our Ref: B-3964 618029-8
) Date: April 28, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria VA, 22313-1450

Sir:

In accordance with the Applicants' duty to disclose information which may be material to the examination of this application, the undersigned respectfully requests that the Examiner consider on the merits the documents listed on the enclosed Form PTO-1449 (modified) before issuing the next Office Action on the merits. We are enclosing herewith a copy of each document listed on the enclosed Form PTO-1449 (modified).

Each item of information contained in this IDS was first cited in the enclosed United Kingdom Examination Report of the corresponding United Kingdom Application No. 0316906.7 (which was mailed on February 10, 2005) not more than three months prior to the filing of this IDS. Therefore, no fees should be due. The Examiner is requested to consider this IDS on the merits.

Please note that the U.S. Patent No. 5,345,105, which is cited in the enclosed United Kingdom Examination Report for the corresponding United Kingdom Application No. 0316906.7, was previously cited in an Information Disclosure Statement (IDS) filed on September 5, 2003 for the subject application; and a copy of U.S. Patent No. 5,345,105 was filed with the September 5, 2003 IDS. Therefore, a copy of U.S. Patent No. 5,345,105 is not enclosed herewith.

This paper is not being filed as a response to the Office Action issued March 18, 2005. A response to that Office Action will be made with a separate filing.

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The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner. (Notice of January 9, 1992, 1135 O.G. 13-25, at 25.) The filing of this Information Disclosure Statement (IDS) shall not be construed as a representation that a search has been made (37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability, or that no other material information exists.

The person making this statement is the practitioner who signs below on the basis of information supplied by an individual associated with the filing and prosecution of this application (37 C.F.R. § 1.56(c)) and on the basis of information in the practitioner's file.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first-class mail in an envelope addressed to the "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450", on April 28, 2005 by Shana Morda.



Respectfully submitted,



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Enclosures: Form PTO-1449 (modified) (1 page)

Copy of documents listed on Form PTO-1449 (modified)



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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-3964 618029-8	U.S. SERIAL NO. 09/768,904
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANT(S) Lap-Wai Chow, et al.	
	FILING DATE January 24, 2001	GROUP 2815

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE or 102(e) DATE IF APPROPRIATE

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	United Kingdom Examination Report for the corresponding United Kingdom Application No. GB0316906.7, issued on February 10, 2005 (3 pages).
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EXAMINER	DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.